



Product Change Notification

Change Notification #: 114117 - 00
Change Title: Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB 1/2 Height PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic 10 Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB, 1/2 Height PCIe 3.0 x4, 20nm, MLC) Generic Single Pack, Intel® SSD DC P3500 Series (400GB, 1.2TB, 2.0TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Generic Single Pack, PCN 114117-00, Product Design, Label, Firmware and Label Update
Date of Publication: October 13, 2015

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Nov 06, 2015
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Description of Change to the Customer:

The Intel® SSD DC P3500 Series SKUs listed in the Products Affected Table below will have the following change.

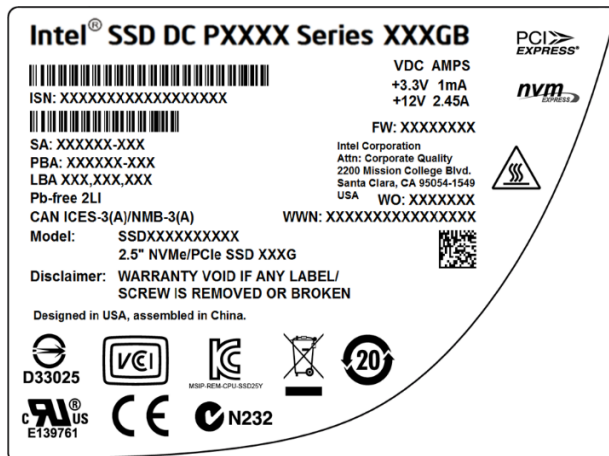
The Intel® SSD DC P3500 Series firmware version is being updated to 8DV10171. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

The following label changes supporting the Australia Regulatory Mark Change:

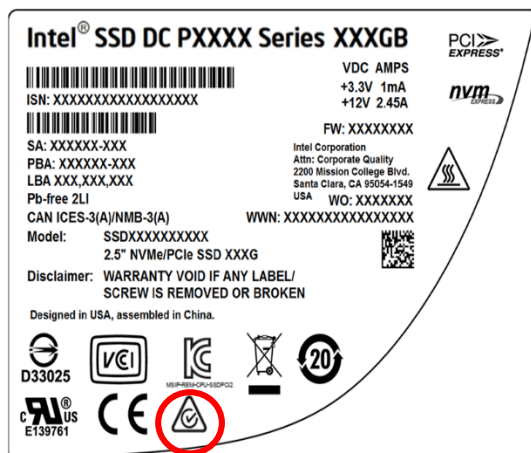
The Australian Communications and Media Authority's (ACMA) labeling arrangements to reflect Regulatory compliance changed on 1 March 2013, to be phased in over a three-year transition period. Products shipping March 1, 2016 need to be labeled with the "RCM" mark. Per ACMA requirements, Intel will be changing the C-Tick regulatory mark on all products to the "RCM" mark.

See the following labels for details:

Example current labels



Example new labels



Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
SSDPE2MX020T401	933086	H26432-202	H59061-201	H26432-203	H59061-202
SSDPEDMX020T401	933095	H26423-301	H59067-300	H26423-302	H59067-301
SSDPE2MX400G401	937519	H49891-201	H59056-201	H49891-202	H59056-202
SSDPE2MX012T401	937521	H49893-201	H59058-201	H49893-202	H59058-202
SSDPEDMX400G401	937525	H49870-300	H59063-300	H49870-301	H59063-301
SSDPEDMX012T401	937527	H49872-300	H59065-300	H49872-301	H59065-301
SSDPE2MX400G410	939931	H59055-201	H59056-201	H59055-202	H59056-202
SSDPE2MX012T410	939932	H59057-201	H59058-201	H59057-202	H59058-202
SSDPE2MX020T410	939933	H59059-201	H59061-201	H59059-202	H59061-202
SSDPEDMX400G410	939934	H59062-300	H59063-300	H59062-301	H59063-301
SSDPEDMX012T410	939935	H59064-300	H59065-300	H59064-301	H59065-301
SSDPEDMX020T410	939936	H59066-300	H59067-300	H59066-301	H59067-301

PCN Revision History:

Date of Revision:

October 13, 2015

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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